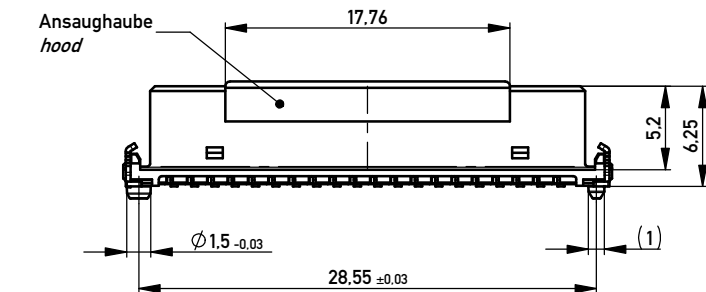
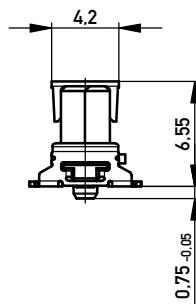
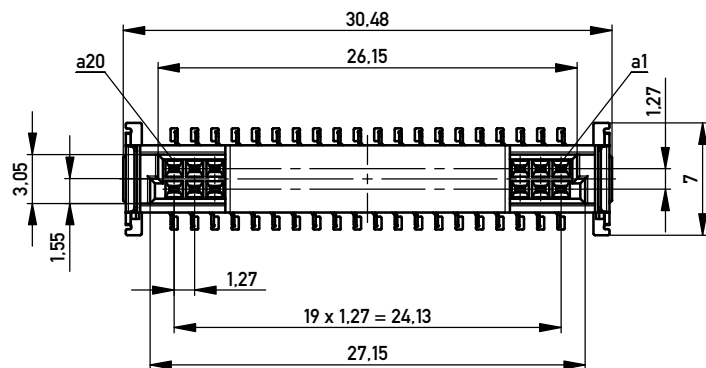


Leiterplatten-Layout Vorschlag für SMT
PCB-Layout Proposal for SMT

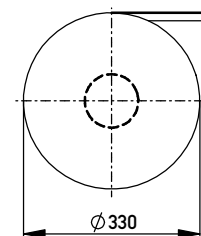
Anforderungsstufe 1
Performance Level 1

Kontaktbereich vergoldet
Mating Area gold plating

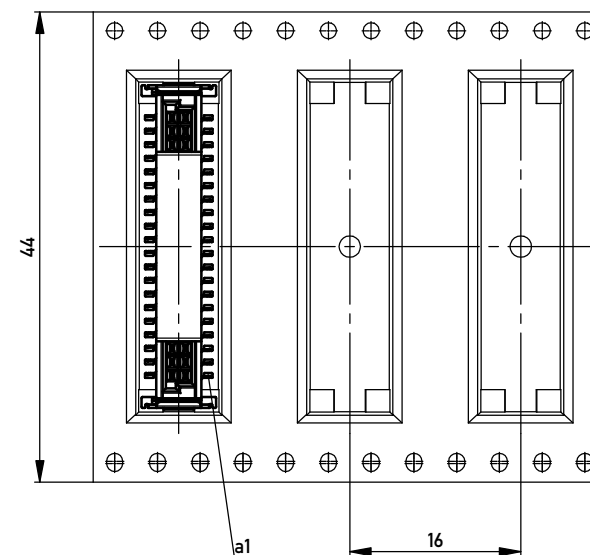
Anschlussbereich verzinkt 4-6 µm
Terminal Area 4-6 µm tin plating

Koplanarität der Anschlüsse ≤ 0,1 mm
Coplanarity Area of Termination ≤ 0,1 mm

Verpackt im Gurt nach DIN IEC 60286-3
Tape on Reel Packaging according to DIN IEC 60286-3
Verpackungseinheit: 280 Stück
Packaging unit: 280 pcs



Abspulrichtung - Reel off Direction



BA 7-13 - 8mm Bauhöhe

type7-13 - low profile

Information:		Tolerances		Scale	3:1
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b		15.01.2014		Federl. SMC-B 40-SMD-BA7-13	
Index		Date		Femle SMC-B 40-SMD-type7-13	
		ERNI www.ERNI.com		204632	
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				SMCB	

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